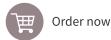


Low noise broadband pre-matched RF bipolar transistor









Product description

The BFR843EL3 is a low noise dual band pre-matched transistor in a low profile package for high speed and low power consumption applications.



Feature list

- Unique combination of high end RF performance and robustness: 20 dBm maximum RF input power and 1 kV HBM ESD hardness
- High transition frequency enables best in class noise performance at high frequencies: $NF_{min} = 1 \text{ dB}$ at 2.4 GHz, 1.8 V, 8 mA and 1.15 dB at 5.5 GHz, 1.8 V, 8 mA
- High gain G_{ms} = 24 dB at 2.4 GHz, 1.8 V, 15 mA and 21.5 dB at 5.5 GHz, 1.8 V, 15 mA
- OIP₃ = 20.5 dBm at 2.4 GHz, 1.8 V, 15 mA and 20.5 dBm at 5.5 GHz, 1.8 V, 15 mA
- Suitable for low voltage applications e.g. $V_{CC} = 1.2 \text{ V}$ and 1.8 V (2.85 V, 3.3 V, 3.6 V require corresponding collector resistor)

Product validation

Qualified for industrial applications according to the relevant tests of JEDEC47/20/22.

Potential applications

- Wireless communications: WLAN 2.4 GHz and 5-6 GHz bands, broadband LTE or WiMAX LNA
- Satellite navigation systems (e.g. GPS, GLONASS, BeiDou, Galileo...) and satellite C-band LNB (1st and 2nd stage LNA)

Device information

Table 1 Part information

Product name / Ordering code	Package	Pin configuration		Marking	Pieces / Reel	
BFR843EL3 / BFR843EL3E6327XTSA1	TSLP-3-10	1 = B	2 = C	3 = E	T2	15000

Attention: ESD (Electrostatic discharge) sensitive device, observe handling precautions

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Absolute maximum ratings

1 Absolute maximum ratings

Table 2 Absolute maximum ratings at $T_A = 25$ °C (unless otherwise specified)

Parameter	Symbol	Va	lues	Unit	Note or test condition
		Min.	Max.		
Collector emitter voltage	ctor emitter voltage V_{CEO} – 2.3	2.25	V	Open base	
			2.0		T _A = -55 °C, open base
Collector emitter voltage 1)	V_{CES}		2.25		E-B short circuited
			2.0		T _A = -55 °C, E-B short circuited
Collector base voltage ²⁾ V _{CBO}	V_{CBO}		2.9		Open emitter
			2.6		T_A = -55 °C, open emitter
Base current	I _B	-1	5	mA	
Collector current	I _C	_	55		
RF input power	P_{RFin}		20	dBm	f = 1.9 GHz, matched to 50 Ω
ESD stress pulse	V_{ESD}	-1	1	kV	HBM, all pins, acc. to JESD22-A114
Total power dissipation 3)	P _{tot}	_	125	mW	<i>T</i> _S ≤ 103 °C
Junction temperature	TJ		150	°C	
Storage temperature	T_{Stg}	-55			

Attention: Stresses above the max. values listed here may cause permanent damage to the device.

Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Exceeding only one of these values may cause irreversible damage to the integrated circuit.

3

 $^{^{1}}$ V_{CES} is similar to V_{CEO} due to design.

 $V_{\rm CBO}$ is similar to $V_{\rm CEO}$ due to design.

 T_S is the soldering point temperature. T_S is measured on the emitter lead at the soldering point of the PCB.



Thermal characteristics

2 Thermal characteristics

Table 3 Thermal resistance

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Тур.	Max.		
Junction - soldering point	R _{thJS}	_	375	_	K/W	

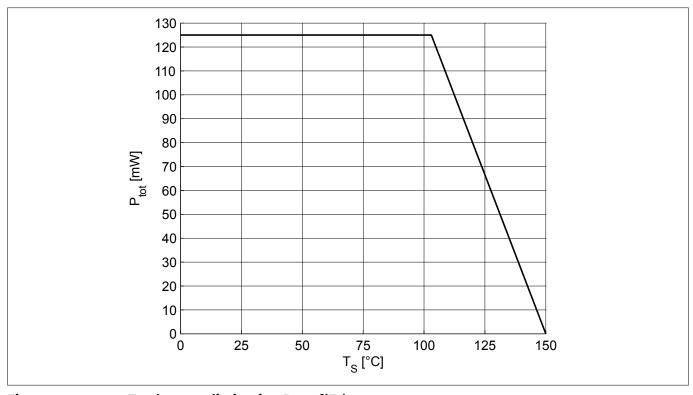


Figure 1 Total power dissipation $P_{tot} = f(T_S)$

Low noise broadband pre-matched RF bipolar transistor



v2.0

Electrical characteristics

Electrical characteristics 3

3.1 **DC** characteristics

DC characteristics at T_A = 25 °C Table 4

Parameter	Symbol	l Values			Unit	Note or test condition
		Min.	Тур.	Max.		
Collector emitter breakdown voltage	V _{(BR)CEO}	2.25	2.6	_	V	$I_C = 1 \text{ mA}, I_B = 0,$ open base
Collector emitter leakage current	I _{CES}	_	_	400 1)	nA	$V_{CE} = 1.5 \text{ V}, V_{BE} = 0,$ E-B short circuited
Collector base leakage current	I _{CBO}			400 ¹⁾		$V_{\text{CB}} = 1.5 \text{ V}, I_{\text{E}} = 0,$ open emitter
Emitter base leakage current	I _{EBO}			10 ¹⁾	μΑ	$V_{\rm EB} = 0.5 \text{V}, I_{\rm C} = 0,$ open collector
DC current gain	h _{FE}	230	360 260	580 -		V_{CE} = 1.8 V, I_C = 1 mA V_{CE} = 1.8 V, I_C = 15 mA Pulse measured

General AC characteristics 3.2

Table 5 General AC characteristics at T_A = 25 °C

Parameter	ter Symbol Values		;	Unit	Note or test condition	
		Min.	Тур.	Max.		
Collector base capacitance ²⁾	C _{CB}	_	5.26	_	pF	f=1 MHz
			0.07			f = 1 GHz
						$V_{CB} = 1.8 \text{ V}, V_{BE} = 0,$ emitter grounded
Collector emitter capacitance	C _{CE}		0.42			f = 1 MHz, $V_{CE} = 1.8 \text{ V}, V_{BE} = 0,$ base grounded
Emitter base capacitance	СЕВ		0.66			f = 1 MHz, $V_{\text{EB}} = 0.4 \text{ V}, V_{\text{CB}} = 0,$ collector grounded

¹ Maximum values not limited by the device but by the short cycle time of the 100% test.

Including integrated feedback capacitance



3.3 Frequency dependent AC characteristics

Measurement setup is a test fixture with Bias-T's in a 50 Ω system, T_A = 25 °C.

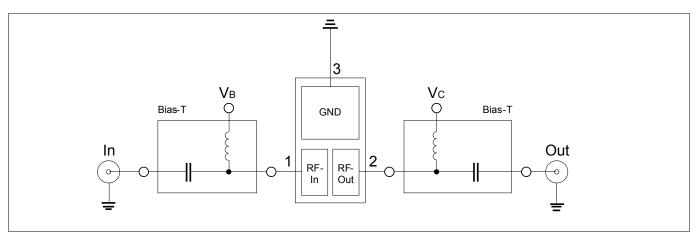


Figure 2 Testing circuit

Table 6 AC characteristics, $V_{CE} = 1.8 \text{ V}, f = 450 \text{ MHz}$

Parameter	Symbol Values		Unit	Note or test condition		
		Min.	Тур.	Max.		
Power gain		_		_	dB	
 Maximum power gain 	G _{ms}		25.5			$I_{\rm C}$ = 15 mA
Transducer gain	$ S_{21} ^2$		24.5			
Noise figure						
 Minimum noise figure 	NF _{min}		0.95			$I_{\rm C}$ = 8 mA
 Associated gain 	G _{ass}		22.5			
Linearity					dBm	
3rd order intercept point at output	OIP ₃		23			$Z_{\rm S} = Z_{\rm L} = 50 \Omega, I_{\rm C} = 15 {\rm m}$
• 1 dB gain compression point at output	OP _{1dB}		7.5			

Low noise broadband pre-matched RF bipolar transistor



Electrical characteristics

Table 7 AC characteristics, $V_{CE} = 1.8 \text{ V}$, f = 900 MHz

Parameter	Symbol		Values			Note or test condition
		Min.	Тур.	Max.		
Power gain		_		_	dB	
 Maximum power gain 	G _{ms}		25			$I_{\rm C} = 15 {\rm mA}$
Transducer gain	$ S_{21} ^2$		24			
Noise figure						
 Minimum noise figure 	NF _{min}		0.95			$I_C = 8 \text{ mA}$
Associated gain	G _{ass}		22			
Linearity					dBm	
 3rd order intercept point at output 	OIP ₃		21.5			$Z_{\rm S} = Z_{\rm L} = 50 \Omega, I_{\rm C} = 15 \rm m$
• 1 dB gain compression point at output	OP _{1dB}		7			

Table 8 AC characteristics, $V_{CE} = 1.8 \text{ V}$, f = 1.5 GHz

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Тур.	Max.		
Power gain		_		_	dB	
Maximum power gain	G _{ms}		24.5			$I_{\rm C} = 15 {\rm mA}$
Transducer gain	$ S_{21} ^2$		23			
Noise figure						
Minimum noise figure	NF _{min}		0.95			$I_{\rm C}$ = 8 mA
Associated gain	G _{ass}		21.5			
Linearity					dBm	
• 3rd order intercept point at output	OIP ₃		21.5			$Z_{\rm S} = Z_{\rm L} = 50 \Omega, I_{\rm C} = 15 \rm mA$
• 1 dB gain compression point at output	OP _{1dB}		7			

Table 9 AC characteristics, $V_{CE} = 1.8 \text{ V}, f = 1.9 \text{ GHz}$

Parameter	Symbol	ol Values		Values Unit		Note or test condition	
		Min.	Тур.	Max.			
Power gain		_		_	dB		
Maximum power gain	G _{ms}		24.5			$I_{\rm C} = 15 {\rm mA}$	
Transducer gain	$ S_{21} ^2$		22.5				
Noise figure							
 Minimum noise figure 	<i>NF</i> _{min}		1			$I_{\rm C}$ = 8 mA	
 Associated gain 	G _{ass}		21				
Linearity					dBm		
3rd order intercept point at output	OIP ₃		21			$Z_{\rm S} = Z_{\rm L} = 50 \Omega, I_{\rm C} = 15 \rm mA$	
• 1 dB gain compression point at output	OP _{1dB}		7				

Low noise broadband pre-matched RF bipolar transistor



Electrical characteristics

Table 10 AC characteristics, $V_{CE} = 1.8 \text{ V}, f = 2.4 \text{ GHz}$

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Тур.	Max.		
Power gain		_		_	dB	
 Maximum power gain 	G _{ms}		24			$I_{\rm C} = 15 {\rm mA}$
Transducer gain	$ S_{21} ^2$		22			
Noise figure						
 Minimum noise figure 	NF _{min}		1			$I_{\rm C}$ = 8 mA
Associated gain	G _{ass}		20			
Linearity					dBm	
3rd order intercept point at output	OIP ₃		20.5			$Z_{\rm S} = Z_{\rm L} = 50 \Omega, I_{\rm C} = 15 \text{m/s}$
• 1 dB gain compression point at output	OP _{1dB}		6			

Table 11 AC characteristics, $V_{CE} = 1.8 \text{ V}, f = 3.5 \text{ GHz}$

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Тур.	Max.		
Power gain		_		_	dB	
 Maximum power gain 	G _{ms}		23			$I_{\rm C} = 15 {\rm mA}$
Transducer gain	$ S_{21} ^2$		19.5			
Noise figure						
 Minimum noise figure 	NF _{min}		1.05			$I_{\rm C}$ = 8 mA
Associated gain	G _{ass}		18.5			
Linearity					dBm	
3rd order intercept point at output	OIP ₃		20.5			$Z_{\rm S} = Z_{\rm L} = 50 \Omega, I_{\rm C} = 15 \rm mA$
• 1 dB gain compression point at output	OP _{1dB}		6			

Table 12 AC characteristics, $V_{CE} = 1.8 \text{ V}, f = 5.5 \text{ GHz}$

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Тур.	Max.		
Power gain		_		_	dB	
 Maximum power gain 	G _{ms}		21.5			$I_{\rm C}$ = 15 mA
Transducer gain	$ S_{21} ^2$		16.5			
Noise figure						
 Minimum noise figure 	NF _{min}		1.15			$I_{\rm C}$ = 8 mA
 Associated gain 	G _{ass}		15.5			
Linearity					dBm	
3rd order intercept point at output	OIP ₃		20.5			$Z_{\rm S} = Z_{\rm L} = 50 \Omega, I_{\rm C} = 15 \rm mA$
• 1 dB gain compression point at output	OP _{1dB}		4.5			

Low noise broadband pre-matched RF bipolar transistor



Electrical characteristics

Table 13 AC characteristics, $V_{CE} = 1.8 \text{ V}, f = 10 \text{ GHz}$

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Тур.	Max.	-	
Power gain		_		_	dB	
Maximum power gain	G _{ma}		14.5			$I_{\rm C} = 15 {\rm mA}$
Transducer gain	$ S_{21} ^2$		10.5			
Noise figure						
 Minimum noise figure 	NF _{min}		1.35			$I_{\rm C}$ = 8 mA
 Associated gain 	G _{ass}		10.5			
Linearity					dBm	
3rd order intercept point at output	OIP ₃		17			$Z_{\rm S} = Z_{\rm L} = 50 \Omega, I_{\rm C} = 15 \rm m_{\rm A}$
• 1 dB gain compression point at output	OP _{1dB}		1.5			

Note:

 $G_{\rm ms}$ = $IS_{21}/S_{12}I$ for k < 1; $G_{\rm ma}$ = $IS_{21}/S_{12}I$ (k-(k^2 -1) $^{1/2}$) for k > 1. In order to get the NF_{min} values stated in this chapter, the test fixture losses have been subtracted from all measured results. OIP₃ value depends on termination of all intermodulation frequency components. Termination used for this measurement is 50 Ω from 0.2 MHz to 12 GHz.



3.4 Characteristic DC diagrams

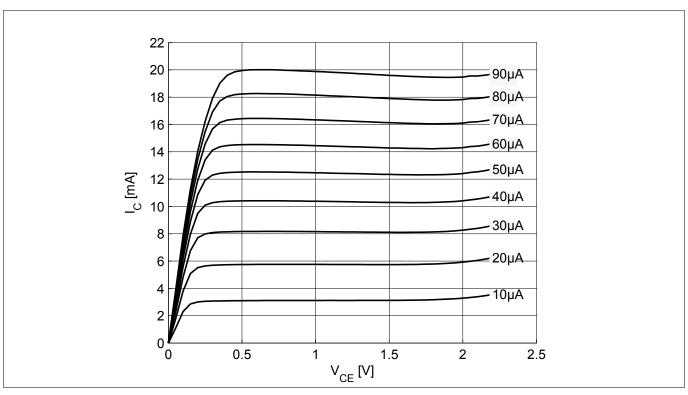


Figure 3 Collector current vs. collector emitter voltage $I_C = f(V_{CE})$, $I_B =$ parameter

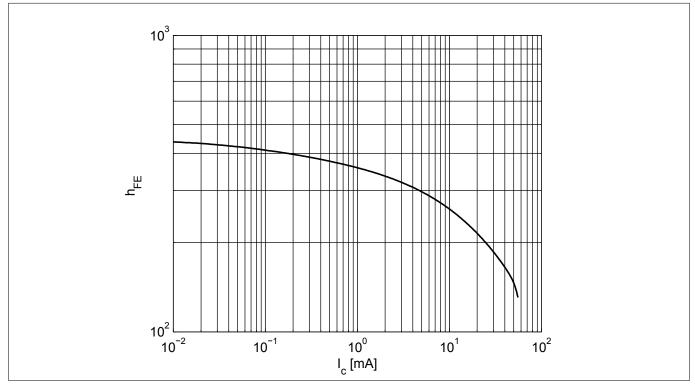


Figure 4 DC current gain $h_{FE} = f(I_C)$, $V_{CE} = 1.8 \text{ V}$



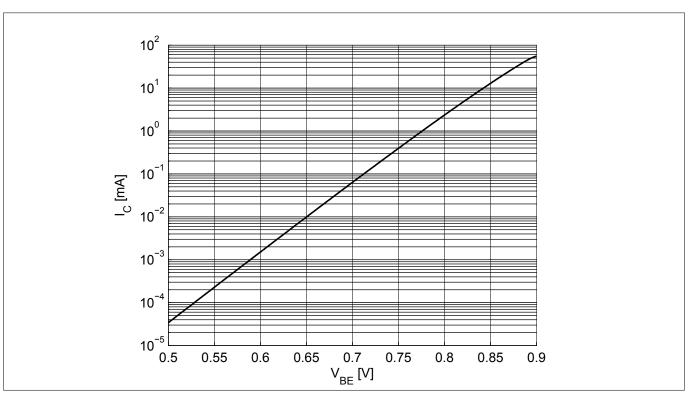


Figure 5 Collector current vs. base emitter forward voltage $I_C = f(V_{BE})$, $V_{CE} = 1.8 \text{ V}$

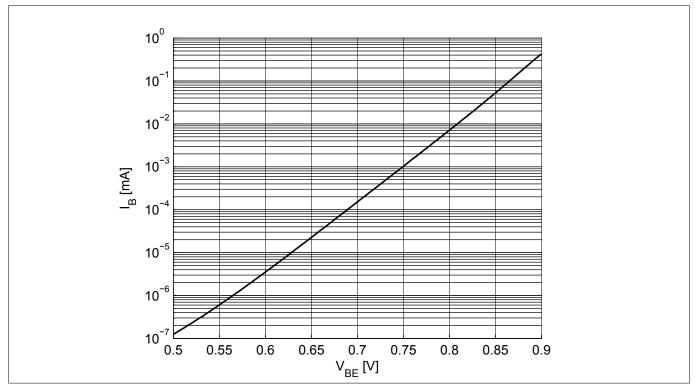


Figure 6 Base current vs. base emitter forward voltage $I_B = f(V_{BE})$, $V_{CE} = 1.8 \text{ V}$

Low noise broadband pre-matched RF bipolar transistor



Electrical characteristics

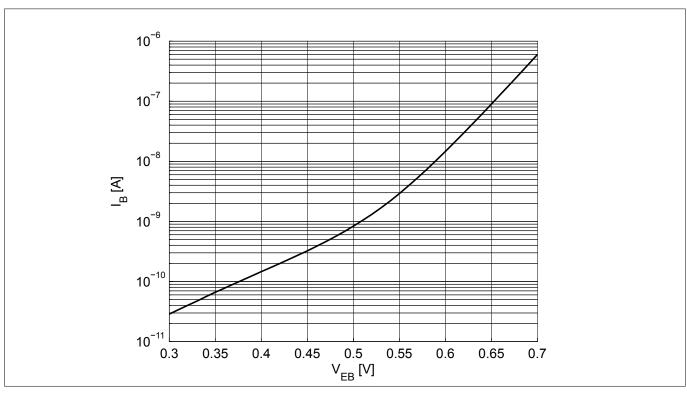


Figure 7 Base current vs. base emitter reverse voltage $I_B = f(V_{EB})$, $V_{CE} = 1.8 \text{ V}$



3.5 Characteristic AC diagrams

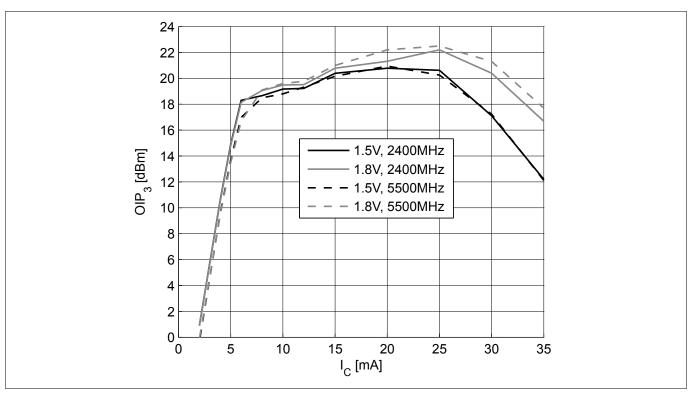


Figure 8 3rd order intercept point $OIP_3 = f(I_C)$, $Z_S = Z_L = 50 \Omega$, V_{CE} , f = parameter

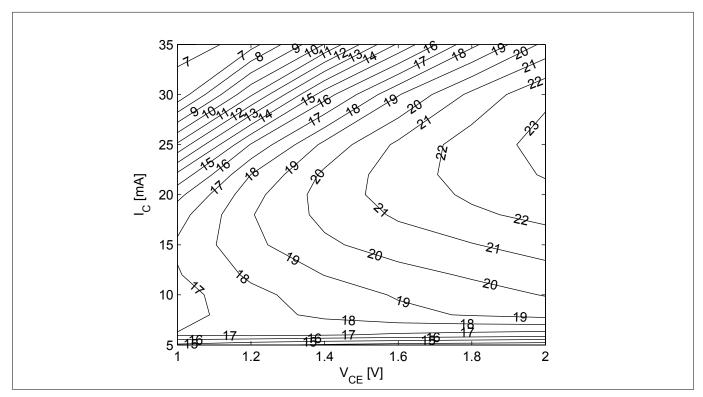


Figure 9 3rd order intercept point at output OIP_3 [dBm] = $f(I_C, V_{CE})$, $Z_S = Z_L = 50 \Omega$, f = 5.5 GHz



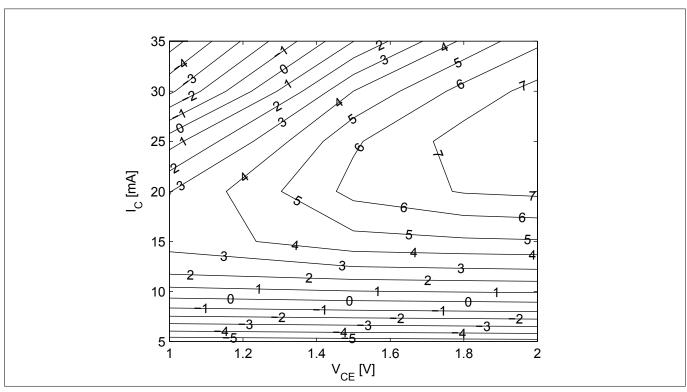


Figure 10 Compression point at output OP_{1dB} [dBm] = $f(I_C, V_{CE}), Z_S = Z_L = 50 \Omega, f = 5.5 \text{ GHz}$

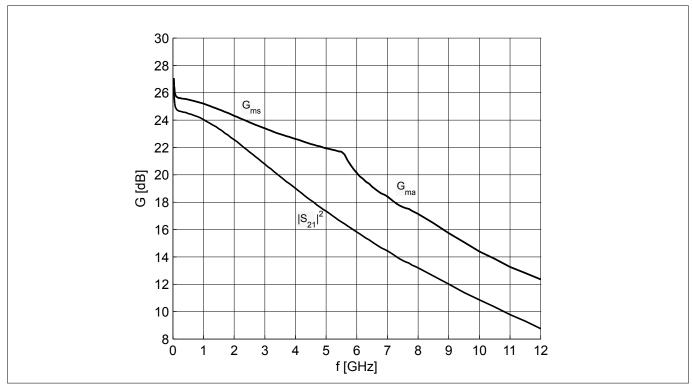


Figure 11 Gain G_{ma} , G_{ms} , $|S_{21}|^2 = f(f)$, $V_{CE} = 1.8 \text{ V}$, $I_C = 15 \text{ mA}$



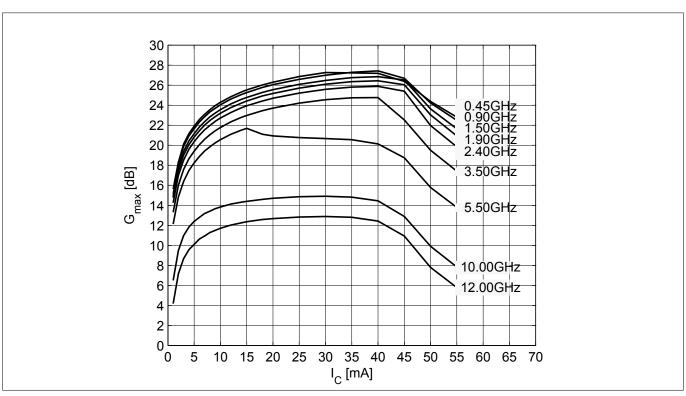


Figure 12 Maximum power gain $G_{\text{max}} = f(I_C)$, $V_{CE} = 1.8 \text{ V}$, f = parameter

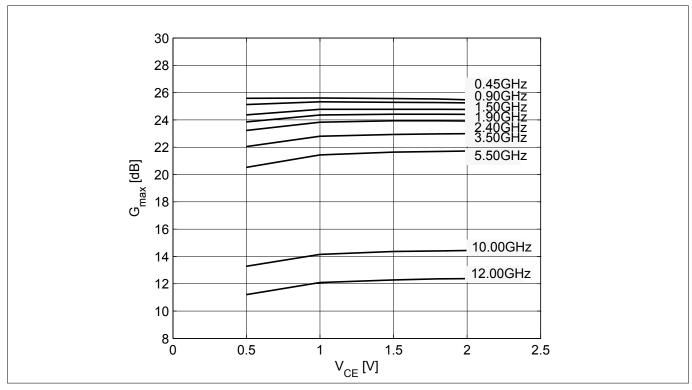


Figure 13 Maximum power gain $G_{\text{max}} = f(V_{\text{CE}})$, $I_{\text{C}} = 15 \text{ mA}$, f = parameter



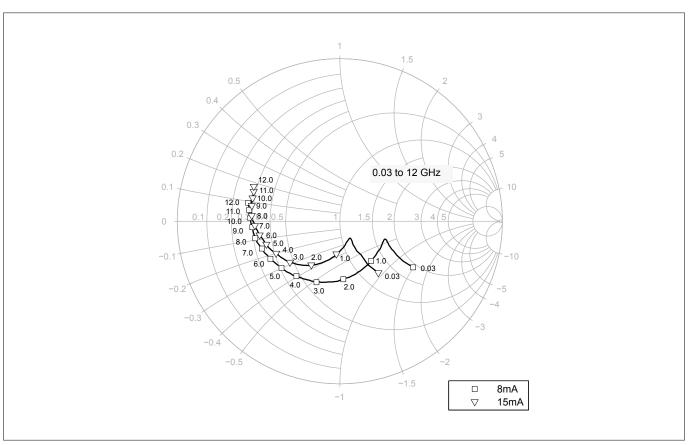


Figure 14 Input reflection coefficient $S_{11} = f(f)$, $V_{CE} = 1.8 \text{ V}$, $I_C = 8 / 15 \text{ mA}$

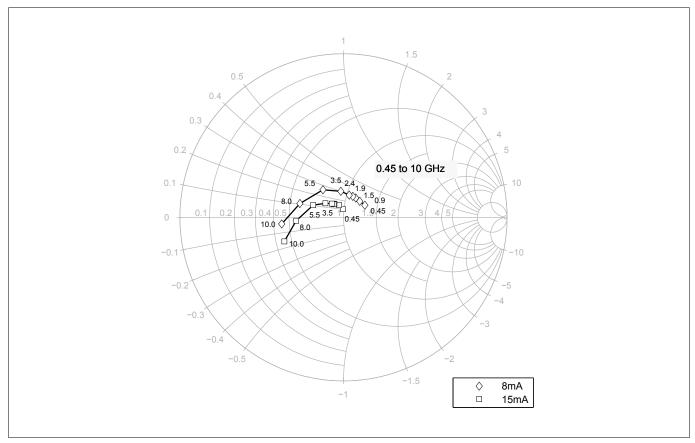


Figure 15 Source impedance for minimum noise figure $Z_{S,opt} = f(f)$, $V_{CE} = 1.8 \text{ V}$, $I_C = 8 / 15 \text{ mA}$



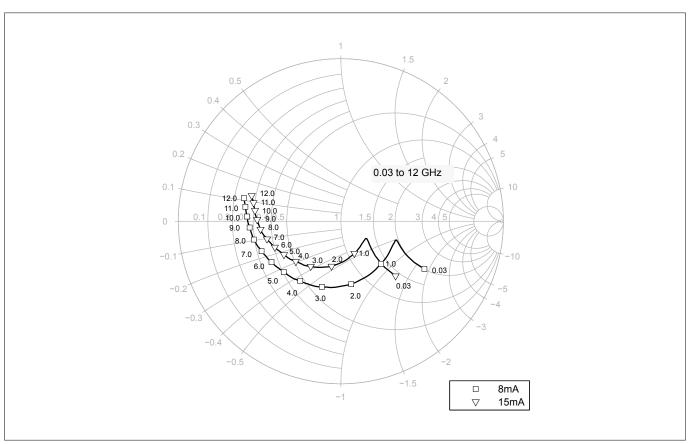


Figure 16 Output reflection coefficient $S_{22} = f(f)$, $V_{CE} = 1.8 \text{ V}$, $I_C = 8 / 15 \text{ mA}$

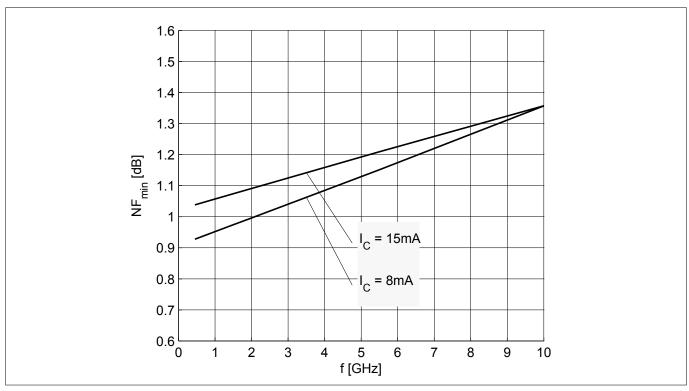


Figure 17 Noise figure $NF_{min} = f(f)$, $V_{CE} = 1.8 \text{ V}$, $Z_S = Z_{S,opt}$, $I_C = 8 / 15 \text{ mA}$



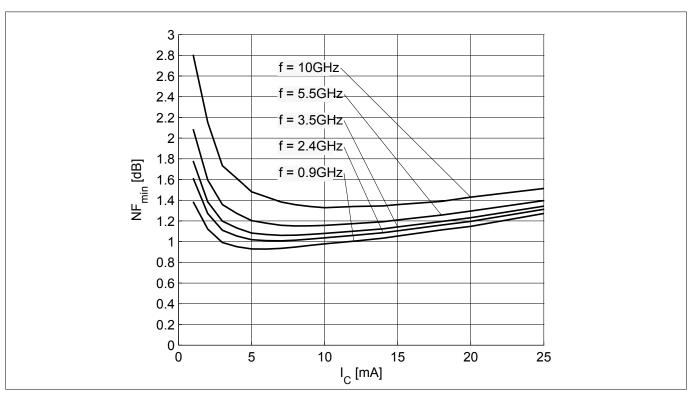


Figure 18 Noise figure $NF_{min} = f(I_C)$, $V_{CE} = 1.8 \text{ V}$, $Z_S = Z_{S,opt}$, f = parameter

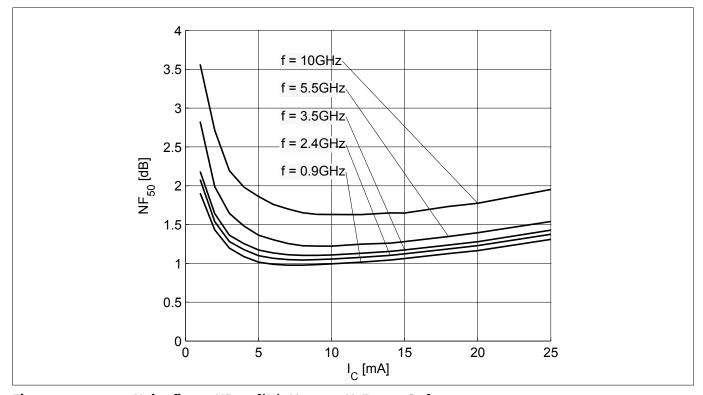


Figure 19 Noise figure $NF_{50} = f(I_C)$, $V_{CE} = 1.8 \text{ V}$, $Z_S = 50 \Omega$, f = parameter

Note: The curves shown in this chapter have been generated using typical devices but shall not be considered as a guarantee that all devices have identical characteristic curves. $T_A = 25 \,^{\circ}\text{C}$.



Package information TSLP-3-10

4 Package information TSLP-3-10

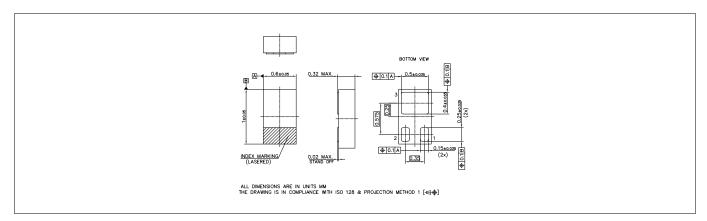


Figure 20 Package outline

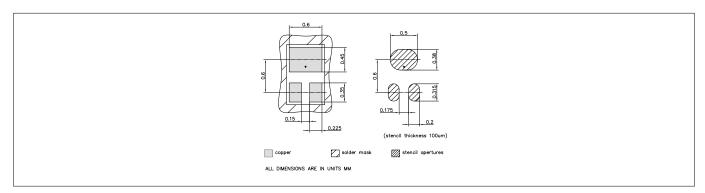


Figure 21 Foot print

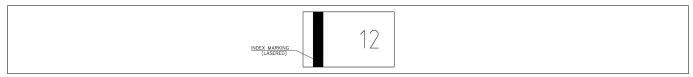


Figure 22 Marking layout example

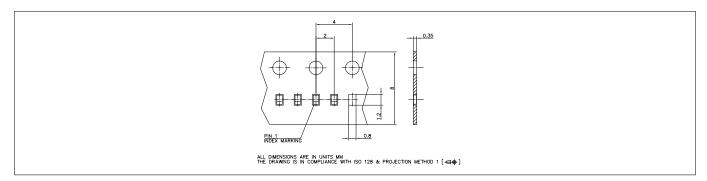


Figure 23 Tape dimensions

Note: See our Recommendations for Printed Circuit Board Assembly of TSLP/TSSLP/TSNP Packages.

The marking layout is an example. For the real marking code refer to the device information on the first page. The number of characters shown in the layout example is not necessarily the real one. The marking layout can consist of less characters.

Low noise broadband pre-matched RF bipolar transistor



Revision history

Revision history

Document version	Date of release	Description of changes
2.0	2018-09-26	New datasheet layout.

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